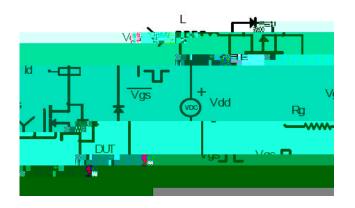
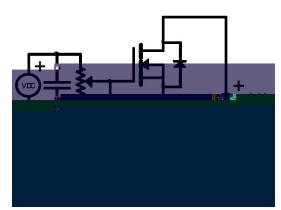
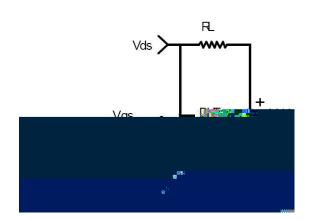


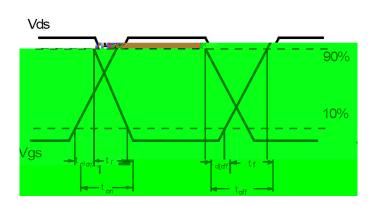
$I_D @ T_C = 25^{\circ}C$	Continuous Drain Current, V _{GS} @ 10V	36	
$I_D @ T_C = 100^{\circ}C$	Continuous Drain Current, V _{GS} @ 10V	25	Α
Іом	Pulsed Drain Current	144	
$P_D @ T_C = 25^{\circ}C$	Power Dissipation	31	W
V_{DS}	Drain-Source Voltage	40	V
V_{GS}	Gate-to-Source Voltage	± 20	V
T _J T _{STG}	Operating Junction and		









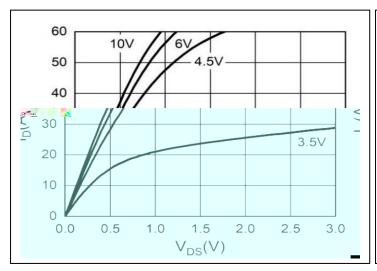


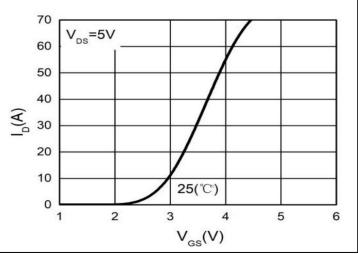
Calculated continuous current based on maximum allowable junction temperature.

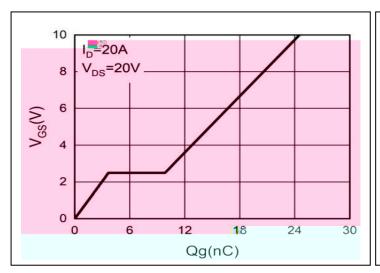
Repetitive rating; pulse width limited by max. junction temperature.

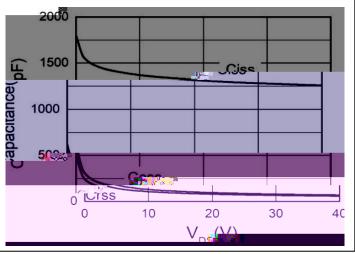
The power dissipation PD is based on max. junction temperature, using junction-to-case thermal resistance.

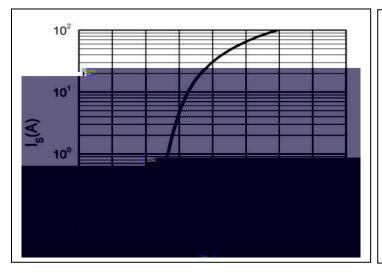


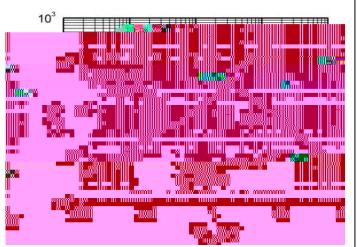




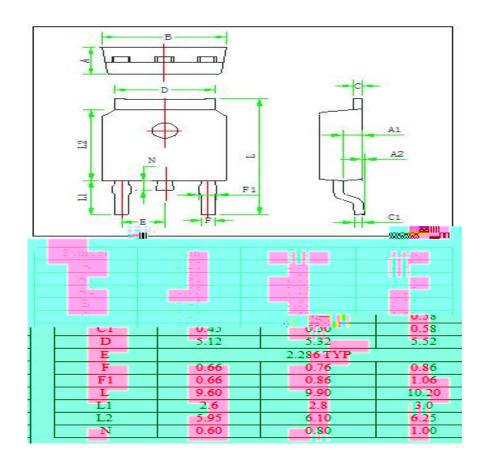














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